ACE1550B

P-Channel Enhancement Mode Field Effect Transistor

Description

The ACE1550B combines advanced trench MOSFET technology with a low resistance package to provide This device is ideal for Power Supply Converter Circuits and Load/Power Switching Cell Phones, Pagers.

Features

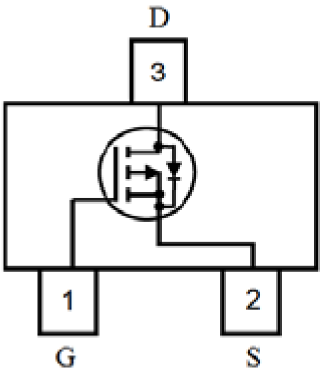
- V_{DS}(V) =-20V
- I_D=-0.7A
- $R_{DS(ON)}$<620mΩ (V_{GS}=-4.5V)
- $R_{DS(ON)}$<860mΩ (V_{GS}=-2.5V)
- $R_{DS(ON)}$<1450mΩ (V_{GS}=-1.8V)

Absolute Maximum Ratings

Parameter		Symbol	Max	Unit
Drain-Source Voltage		V_{DSS}	-20	V
Gate-Source Voltage		V_{GSS}	±12	V
Continuous Drain Current * AC	T_A=25℃	I_D	-0.7	A
	T_A=70℃		-0.56	
Pulsed Drain Current * B		I_{DM}	-1	A
Power Dissipation	T_A=25℃	P_D	0.27	W
	T_A=70℃		0.16	
Operating Junction Temperature / Storage Temperature Range		T_J/T_{STG}	-55/150	°C

Packaging Type

SOT-523



Ordering information

ACE1550B XX + H

- H: Halogen - free
- +: Pb - free
- XX: KM : SOT-523

Electrical Characteristics

T_A=25℃, unless otherwise specified.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V, I_D=-250 uA	-20			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_{DS}=-250uA	-0.3		-0.8	V
Gate Leakage Current	I_{GSS}	V_{DS}=0V,V_{GS}=±12V			100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-20V, V_{GS}=0V			1	uA
Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}=-4.5V, I_D=-0.6A		500	620	mΩ
		V_{GS}=-2.5V, I_D=-0.5A		700	860	
		V_{GS}=-1.8V, I_D=-0.4A		1000	1450	
Forward Transconductance	gfs	V_{DS}=-10V,I_D=-0.4A		1		S
Diode Forward Voltage	V_{SD}	I_{SD}=-0.15A, V_{GS}=0V		-0.65	-1.2	V
Switching						
Total Gate Charge	Q_g	V_{DS}=-10V, V_{GS}=-4.5V, I_D=-0.25A		1.0	1.3	nC
Gate-Source Charge	Q_{gs}			0.1		
Gate-Drain Charge	Q_{gd}			0.3		
Turn-On Time	td(on)	V_{GS}=-4.5V, I_D=-0.2A, V_{DS}=-10V, R_G=10Ω		10	15	nS
	tr			10	15	
Turn-Off Time	td(off)			40	60	
	tf			30	50	
Dynamic						
Input Capacitance	Ciss	V_{GS}=0V, V_{DS}=-10V, f=1MHz		70	100	pF
Output Capacitance	Coss			20		
REVERSE Transfer Capacitance	Crss			10		

Note:

1. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The value in any given application depends on the user's specific board design.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JA}$ and lead to ambient .
4. The static characteristics are obtained using <300 μs pulses, duty cycle 0.5% max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The SOA curve provides a single pulse rating.

Typical Performance Characteristics

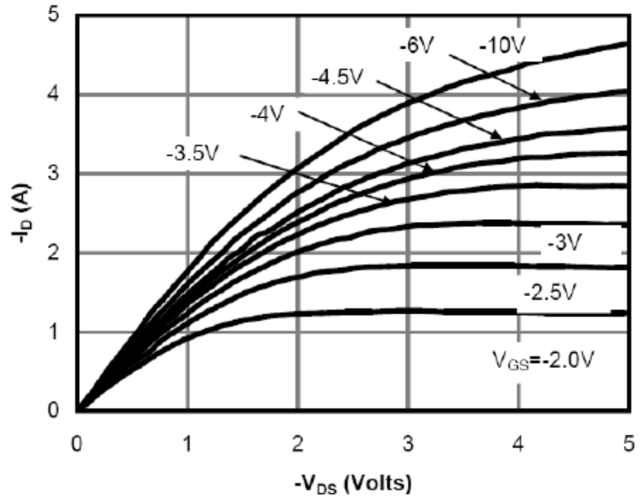


Figure 1: On-Region Characteristics

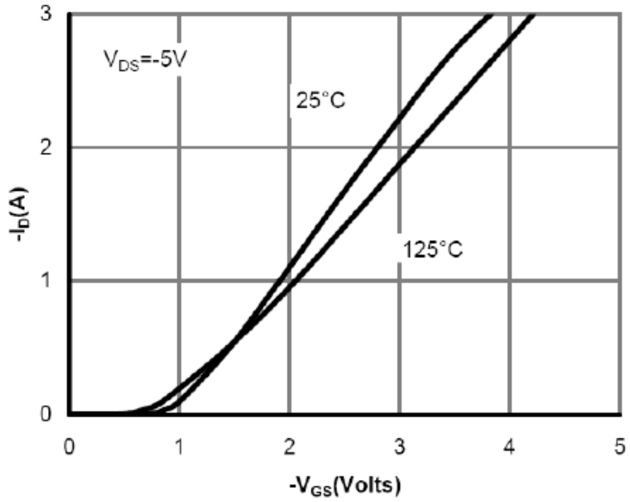


Figure 2: Transfer Characteristics

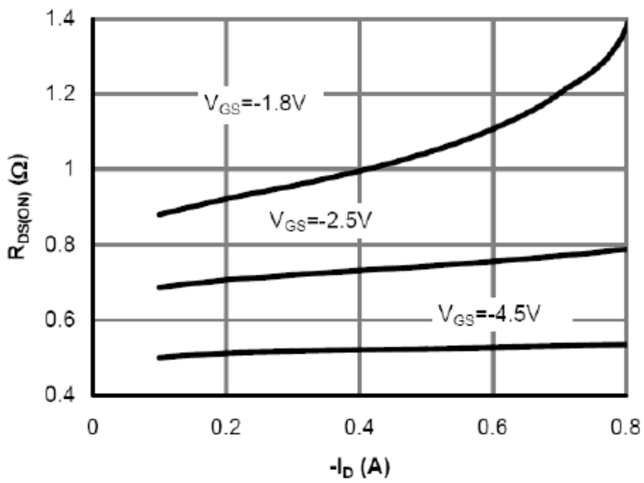


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

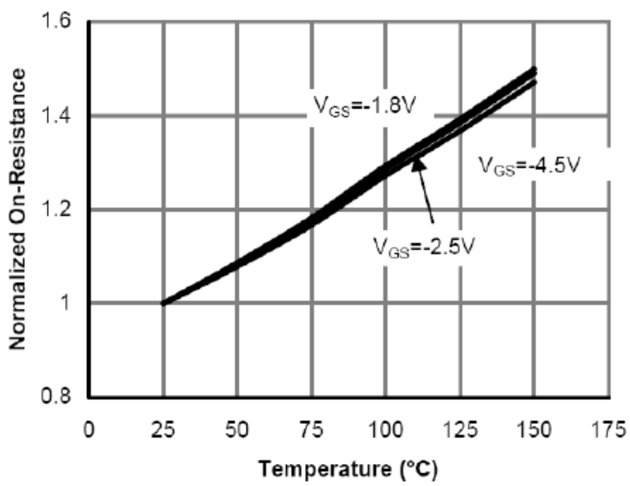


Figure 4: On-Resistance vs. Junction Temperature

Typical Performance Characteristics

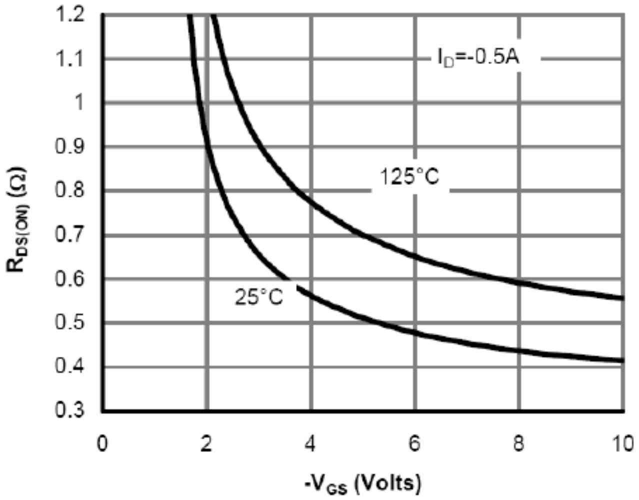


Figure 5: On-Resistance vs. Gate-Source Voltage

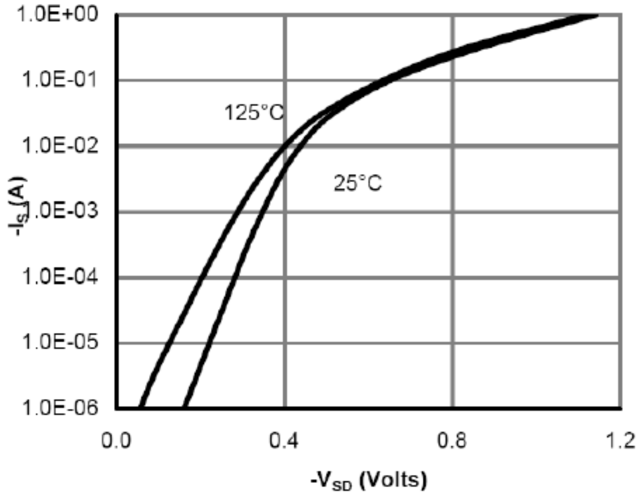


Figure 6: Body-Diode Characteristics

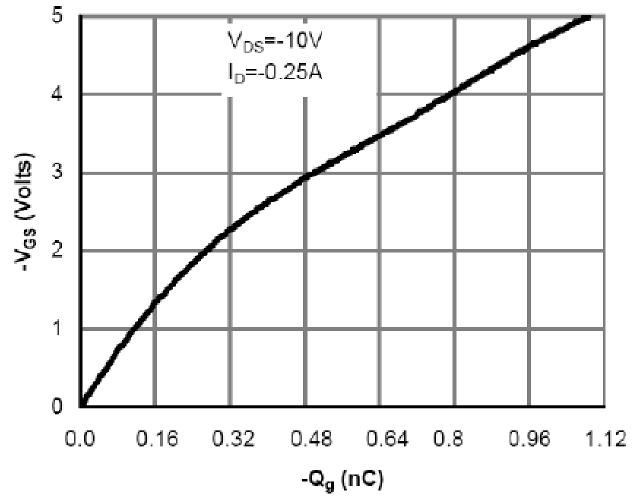


Figure 7: Gate-Charge Characteristics

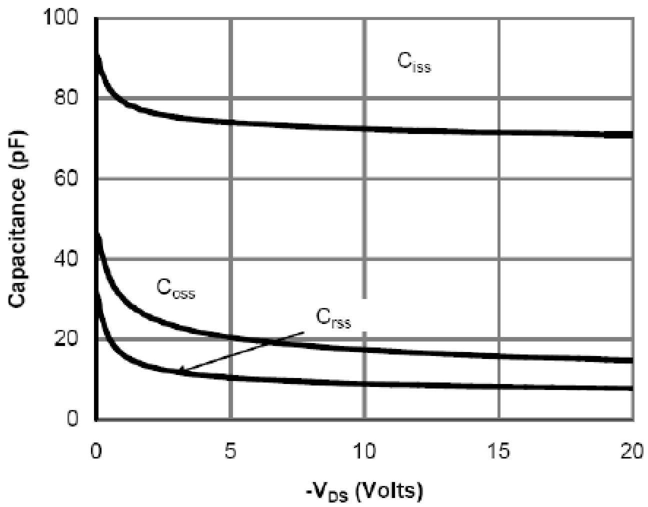


Figure 8: Capacitance Characteristics

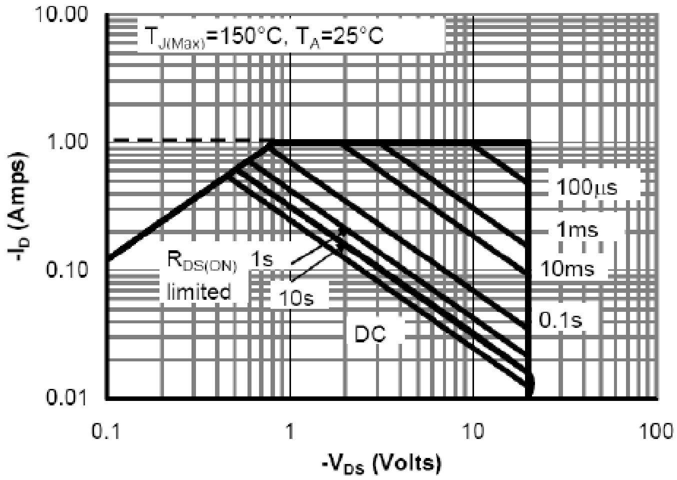


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

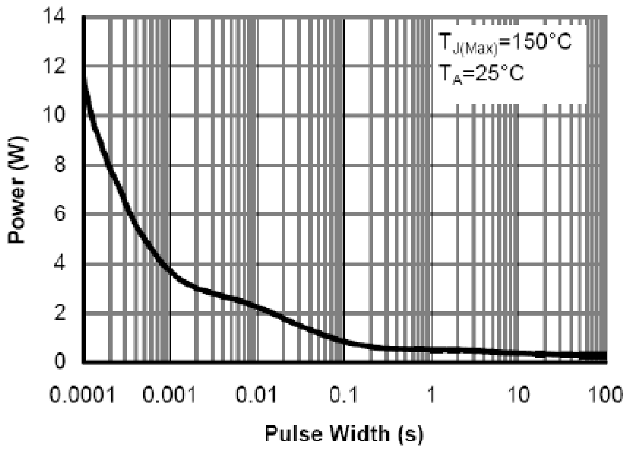


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

Typical Performance Characteristics

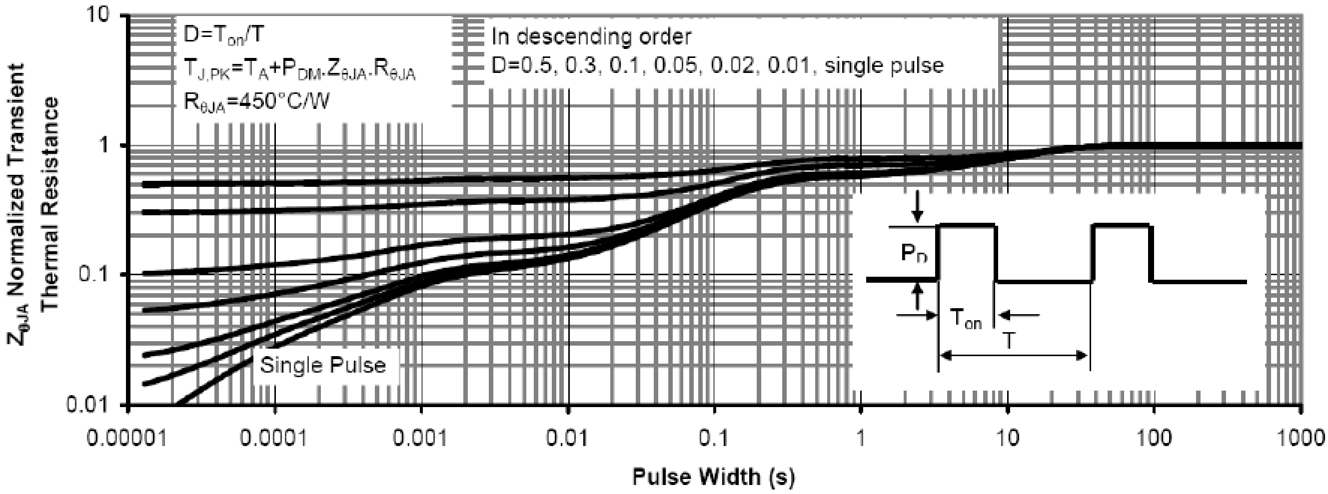
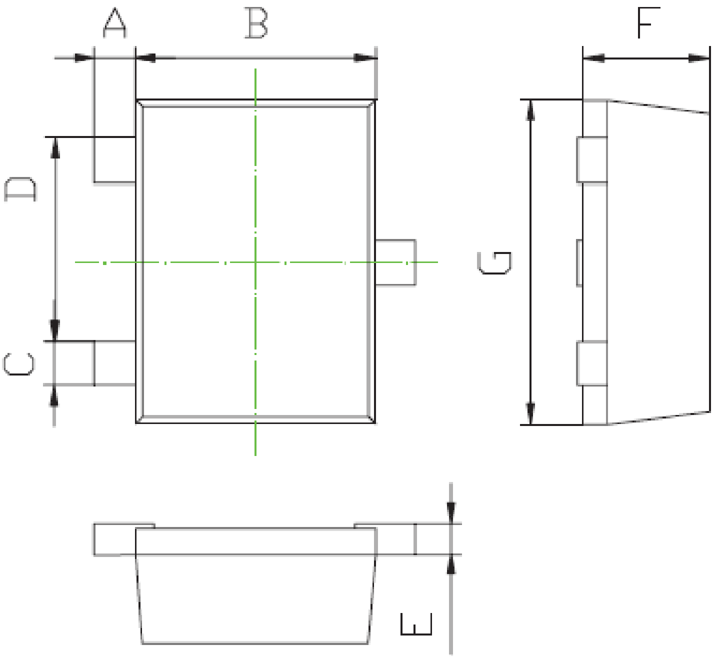


Figure 11: Normalized Maximum Transient Thermal Impedance

Packing Information

SOT-523



Unit:mm			
Dim.	Min.	Typ.	Max.
A	0.1	0.2	0.3
B	1.10	1.20	1.30
C	0.17	0.22	0.27
D	0.95	1.00	1.05
E	0.09	0.125	0.16
F	0.525	0.575	0.60
G	1.5	1.6	1.7

+Notes

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and shoes failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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